Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	400
Number of Logic Elements/Cells	950
Total RAM Bits	-
Number of I/O	129
Number of Gates	10000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc4010d-5pq160c

XC4000 Compared to XC3000A

For those readers already familiar with the XC3000A family of Xilinx Field Programmable Gate Arrays, here is a concise list of the major new features in the XC4000 family.

CLB has two **independent** 4-input function generators. A **third** function generator combines the outputs of the two other function generators with a ninth input. All function inputs are swappable, all have full access; none are mutually exclusive.
CLB has **very fast arithmetic carry** capability.
CLB function generator look-up table can also be used as high-speed **RAM.**
CLB flip-flops have asynchronous set **or** reset.
CLB has **four outputs**, two flip-flops, two combinatorial.
CLB connections symmetrically located on all **four** edges.

IOB has more versatile clocking polarity options.
IOB has programmable input set-up time:
long to avoid potential hold time problems,
short to improve performance.
IOB has Longline access through its own TBUF.
Outputs are **n-channel only**, lower V_{OH} increases speed.
XC4000 outputs can be paired to double sink current to **24 mA.** XC4000A and XC4000H outputs can each sink 24 mA**,** can be paired for **48 mA** sink current.

IEEE 1149.1- type **boundary scan** is supported in the I/O.

Wide decoders on all four edges of the LCA device.

Increased **number of interconnect resources.**
All CLB inputs and outputs have **access to most interconnect lines.**
Switch Matrices are simplified to increase speed.
Eight global nets can be used for clocking or distributing logic signals.
TBUF output configuration is more versatile and 3-state control less confined.

Program is single-function input pin,overrides everything.
INIT pin also acts as Configuration Error output.

Peripheral Synchronous Mode (8 bit) has been added.
Peripheral Asynchronous Mode has improved handshake.
Start-up can be **synchronized** to any user clock (this is a configuration option).
No Powerdown, but instead a **Global 3-state input** that does not reset any flip-flops.
No on-chip **crystal oscillator** amplifier.

Configuration Bit Stream includes **CRC error checking.**
Configuration Clock can be increased to >**8 MHz.**
Configuration Clock is **fully static**, no constraint on the maximum Low time.

Readback either ignores flip-flop content (avoids need for masking) or it takes a **snapshot** of all flip-flops at the start of Readback.
Readback has same **polarity** as Configuration and can be **aborted.**

Table 2. Three Generations of Xilinx Field-Programmable Gate Array Families

Parameter	XC4025	XC3195A	XC2018
Number of flip-flops	2,560	1,320	174
Max number of user I/O	256	176	74
Max number of RAM bits	32,768	0	0
Function generators per CLB	3	2	2
Number of logic inputs per CLB	9	5	4
Number of logic outputs per CLB	4	2	2
Number of low-skew global nets	8	2	2
Dedicated decoders	yes	no	no
Fast carry logic	yes	no	no
Internal 3-state drivers	yes	yes	no
Output slew-rate control	yes	yes	no
Power-down option	no	yes	yes
Crystal oscillator circuit	no	yes	yes

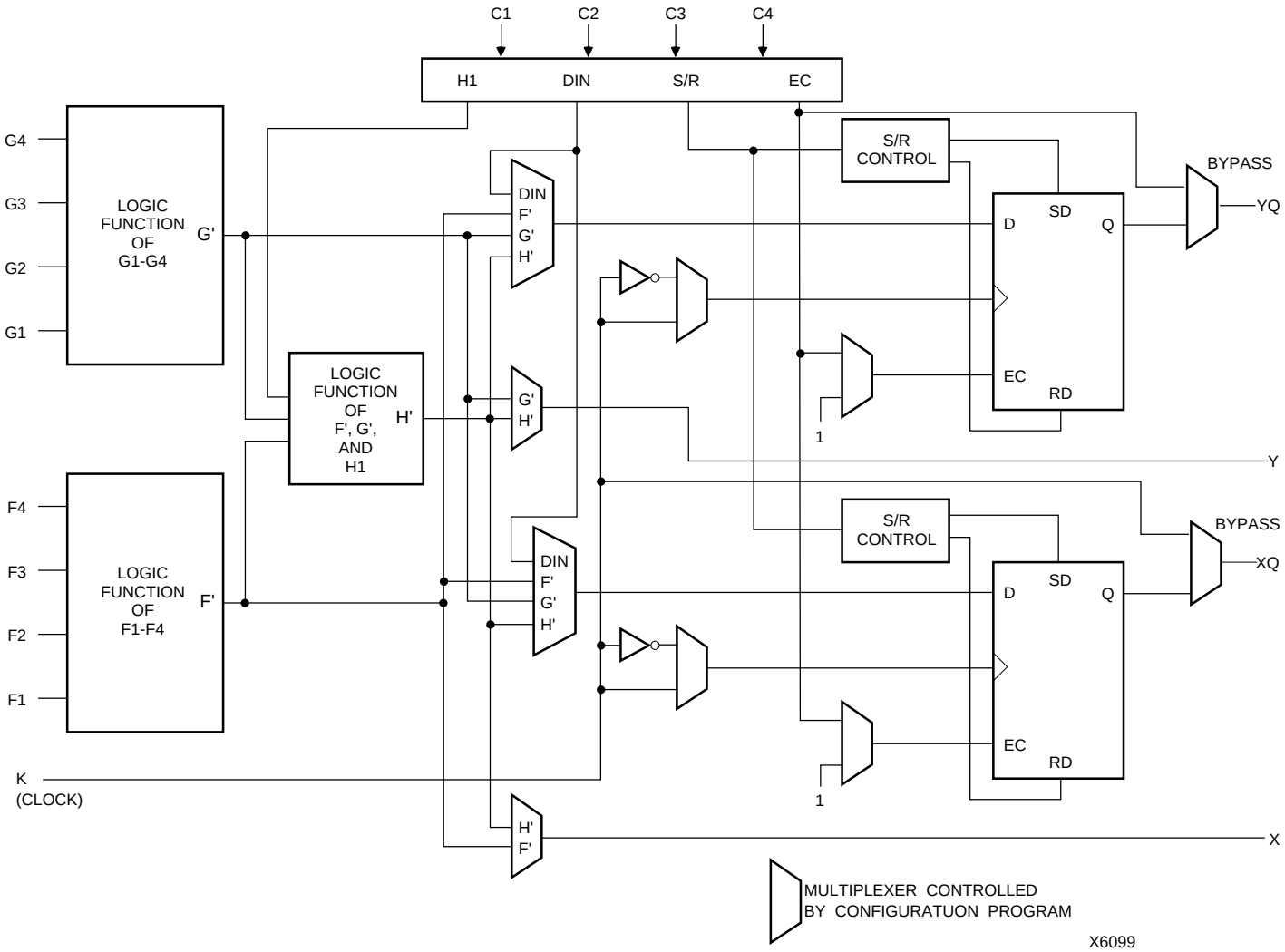


Figure 1. Simplified Block Diagram of XC4000-Families Configurable Logic Block

independently for each of the two registers; this input also can be disabled for either flip-flop. A separate global Set/Reset line (not shown in Figure 1) sets or clears each register during power-up, reconfiguration, or when a dedicated Reset net is driven active. This Reset net does not compete with other routing resources; it can be connected to any package pin as a global reset input.

Each flip-flop can be triggered on either the rising or falling clock edge. The source of a flip-flop data input is programmable: it is driven either by the functions F', G', and H', or the Direct In (DIN) block input . The flip-flops drive the XQ and YQ CLB outputs.

In addition, each CLB F' and G' function generator contains dedicated arithmetic logic for the fast generation of carry and borrow signals, greatly increasing the efficiency and performance of adders, subtracters, accumulators, comparators and even counters.

Multiplexers in the CLB map the four control inputs, labeled C1 through C4 in Figure 1, into the four internal control signals (H1, DIN, S/R, and EC) in any arbitrary manner.

The flexibility and symmetry of the CLB architecture facilitates the placement and routing of a given application. Since the function generators and flip-flops have independent inputs and outputs, each can be treated as a separate entity during placement to achieve high packing density. Inputs, outputs, and the functions themselves can freely swap positions within a CLB to avoid routing congestion during the placement and routing operation.

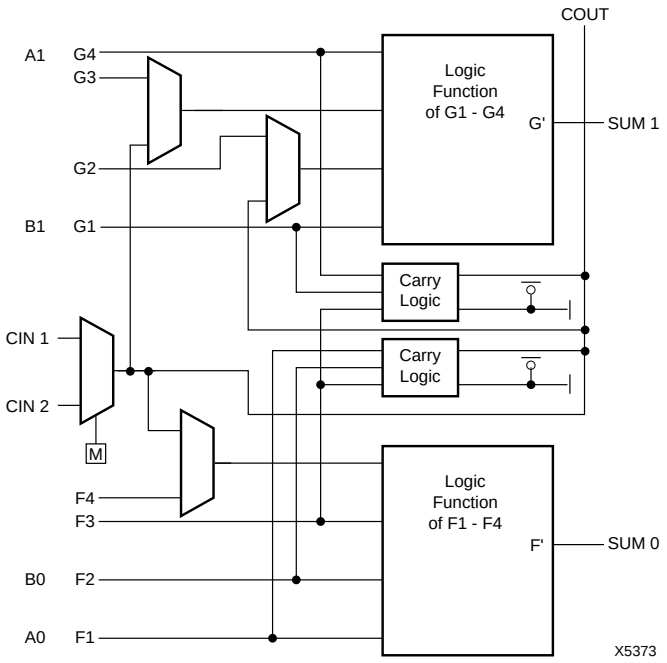


Figure 2. Fast Carry Logic in Each CLB

up/down counter, this means twice the speed in half the number of CLBs, compared with the XC3000 families.

Pipelining Speeds Up The System: The abundance of flip-flops in the CLBs invites pipelined designs. This is a powerful way of increasing performance by breaking the function into smaller subfunctions and executing them in parallel, passing on the results through pipeline flip-flops. This method should be seriously considered wherever total performance is more important than simple through-delay.

Wide Edge Decoding: For years, FPGAs have suffered from the lack of wide decoding circuitry. When the address or data field is wider than the function generator inputs (five bits in the XC3000 families), FPGAs need multi-level decoding and are thus slower than PALs. The XC4000-family CLBs have nine inputs; any decoder of up to nine inputs is, therefore, compact and fast. But, there is also a need for much wider decoders, especially for address decoding in large microprocessor systems. The XC4000 family has four programmable decoders located on each edge of each device. Each of these wired-AND gates is capable of accepting up to 42 inputs on the XC4005 and 72 on the XC4013. These decoders may also be split in two when a large number of narrower decoders are required for a maximum of 32 per device. These dedicated decoders accept I/O signals and internal signals as inputs and generate a decoded internal signal in 18 ns, pin-to-pin. The XC4000A family has only two decoder AND gates per edge which, when split provide a maximum of 16 per device. Very large PALs can be emulated by ORing the decoder outputs in a CLB. This decoding feature covers what has long been considered a weakness of FPGAs. Users often resorted to external PALs for simple but fast decoding functions. Now, the dedicated decoders in the XC4000 can implement these functions efficiently and fast.

Higher Output Current: The 4-mA maximum output current specification of today's FPGAs often forces the user to add external buffers, cumbersome especially on bidirectional I/O lines. The XC4000 families solve many of these problems by increasing the maximum output sink current to 12 mA. Two adjacent outputs may be interconnected to increase the output sink current to 24 mA. The FPGA can thus drive short buses on a pc board. The XC4000A and XC4000H outputs can sink 24 mA per output and can double up for 48 mA.

While the XC2000 and XC3000 families used complementary output transistors, the XC4000 outputs are n-channel for both pull-down and pull-up, somewhat analogous to the classical totem pole used in TTL. The reduced output High level (VOH) makes circuit delays more symmetrical for TTL-threshold systems. The XC4000H outputs have an optional p-channel output transistor.

Abundant Routing Resources

Connections between blocks are made by metal lines with programmable switching points and switching matrices. Compared to the previous LCA families, these routing resources have been increased dramatically.The number of globally distributed signals has been increased from two to eight, and these lines have access to any clock or logic input. The designer of synchronous systems can now distribute not only several clocks, but also control signals, all over the chip, without having to worry about any skew.

There are more than twice as many horizontal and vertical Longlines that can carry signals across the length or width of the chip with minimal delay and negligible skew.The horizontal Longlines can be driven by 3-state buffers, and can thus be used as unidirectional or bidirectional data buses; or they can implement wide multiplexers or wired-AND functions.

Single-length lines connect the switching matrices that are located at every intersection of a row and a column of CLBs. These lines provide the greatest interconnect flexibility, but cause a delay whenever they go through a switching matrix. Double-length lines bypass every other matrix, and provide faster signal routing over intermediate distances.

Compared to the XC3000 family, the XC4000 families have more than double the routing resources, and they are arranged in a far more regular fashion. In older devices,

inputs could not be driven by all adjacent routing lines. In the XC4000 families, these constraints have been largely eliminated. This makes it easier for the software to complete the routing of complex interconnect patterns.

Chip architects and software designers worked closely together to achieve a solution that is not only inherently powerful, but also easy to utilize by the software-driven design tools for Partitioning, Placement and Routing. The goal was to provide automated push-button software tools that complete almost all designs, even large and dense ones, automatically, without operator assistance. But these tools will still give the designer the option to get involved in the partitioning, placement and, to a lesser extent, even the routing of critical parts of the design, if that is needed to optimize the performance.

On-Chip Memory

The XC4000, XC4000A and XC4000H family devices are the first programmable logic devices with RAM accessible to the user.

An optional mode for each CLB makes the memory look-up tables in the F' and G' function generators usable as either a 16 x 2 or 32 x 1 bit array of Read/Write memory cells (Figure 3). The F1-F4 and G1-G4 inputs to the function generators act as address lines, selecting a particular memory cell in each look-up table. The functionality of the CLB control signals change in this configuration; the H1, DIN, and S/R lines become the two data inputs and the Write Enable (WE) input for the 16 x 2 memory. When the 32 x 1 configuration is selected, D1 acts as the fifth address bit and D0 is the data input. The contents of the memory cell(s) being addressed are available at the F' and G' function-generator outputs, and can exit the CLB through its X and Y outputs, or can be pipelined using the CLB flip-flop(s).

Configuring the CLB function generators as Read/Write memory does not affect the functionality of the other portions of the CLB, with the exception of the redefinition of the control signals. The H' function generator can be used to implement Boolean functions of F', G', and D1, and the D flip-flops can latch the F', G', H', or D0 signals.

The RAMs are very fast; read access is the same as logic delay, about 5.5 ns; write time is about 8 ns; both are several times faster than any off-chip solution. Such distributed RAM is a novel concept, creating new possibilities in system design: registered arrays of multiple accumulators, status registers, index registers, DMA counters, distributed shift registers, LIFO stacks, and FIFO buffers. The data path of a 16-byte FIFO uses four CLBs for storage, and six CLBs for address counting and multiplexing (Figure 4). With 32 storage locations per CLB, compared to two flip-flops per CLB, the cost of intelligent distributed memory has been reduced by a factor of 16.

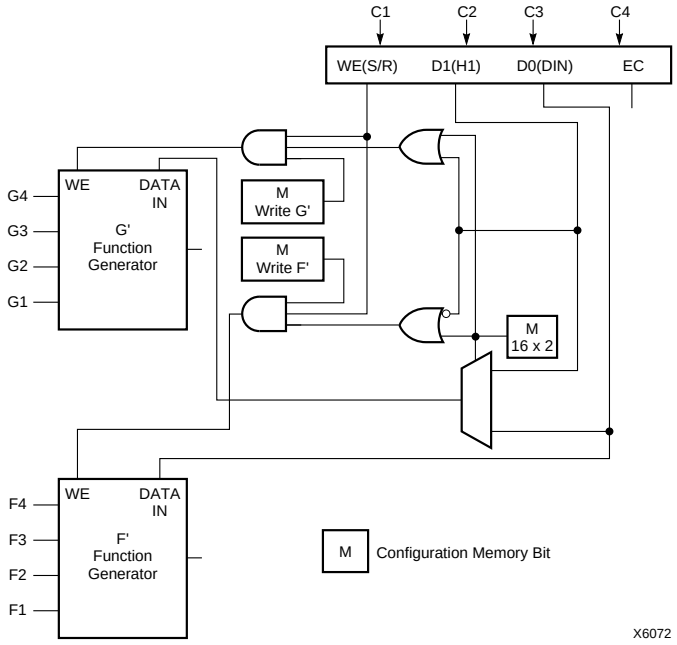


Figure 3. CLB Function Generators Can Be Used as Read/Write Memory Cells

Input/Output Blocks (IOBs), XC4000 and XC4000A Families (for XC4000H family, see page 2-82)

User-configurable IOBs provide the interface between external package pins and the internal logic (Figure 5). Each IOB controls one package pin and can be defined for input, output, or bidirectional signals.

Two paths, labeled I1 and I2, bring input signals into the array. Inputs are routed to an input register that can be programmed as either an edge-triggered flip-flop or a level-sensitive transparent latch. Optionally, the data input to the register can be delayed by several nanoseconds to compensate for the delay on the clock signal, that first must

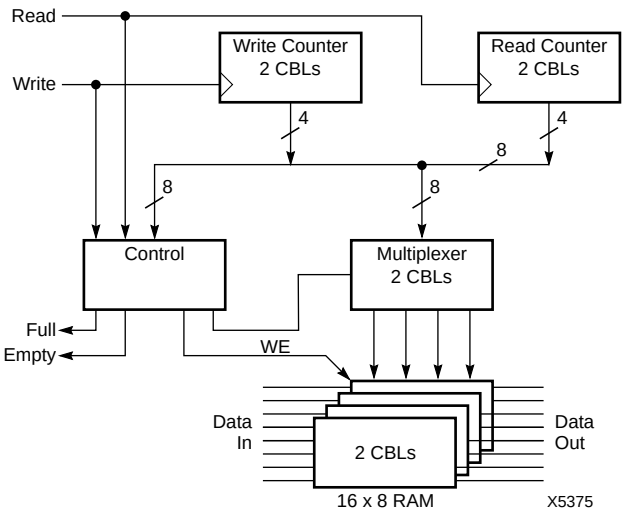


Figure 4. 16-byte FIFO

surrounding one CLB in the array. Each Switch Matrix consists of programmable n-channel pass transistors used to establish connections between the single-length lines (Figure 7). For example, a signal entering on the right side of the Switch Matrix can be routed to a single-length line on the top, left, or bottom sides, or any combination thereof, if multiple branches are required. Single-length lines are normally used to conduct signals within a localized area and to provide the branching for nets with fanout greater than one.

Compared to the previous generations of LCA architectures, the number of possible connections through the Switch Matrix has been reduced. This decreases capacitive loading and minimizes routing delays, thus increasing performance. However, a much more versatile set of connections between the single-length lines and the CLB inputs and outputs more than compensate for the reduction in Switch Matrix options, resulting in overall increased routability.

The function generator and control inputs to the CLB (F1-F4, G1-G4, and C1-C4) can be driven from any adjacent single-length line segment (Figure 6). The CLB clock (K) input can be driven from one-half of the adjacent single-length lines. Each CLB output can drive several of the single-length lines, with connections to both the horizontal and vertical Longlines.

The double-length lines (Figure 8) consist of a grid of metal segments twice as long as the single-length lines; i.e, a double-length line runs past two CLBs before entering a Switch Matrix. Double-length lines are grouped in pairs with the Switch Matrices staggered so that each line goes through a Switch Matrix at every other CLB location in that row or column. As with single-length lines, all the CLB inputs except K can be driven from any adjacent double-length line, and each CLB output can drive nearby double-length lines in both the vertical and horizontal planes. Double-length lines provide the most efficient implementation of intermediate length, point-to-point interconnections.

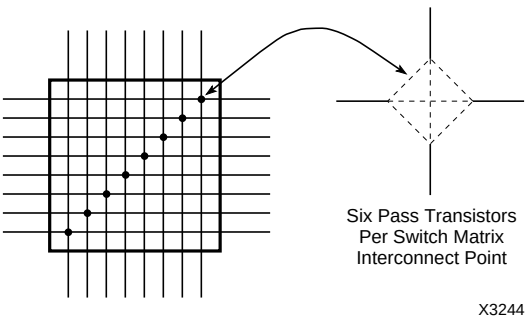


Figure 7. Switch Matrix

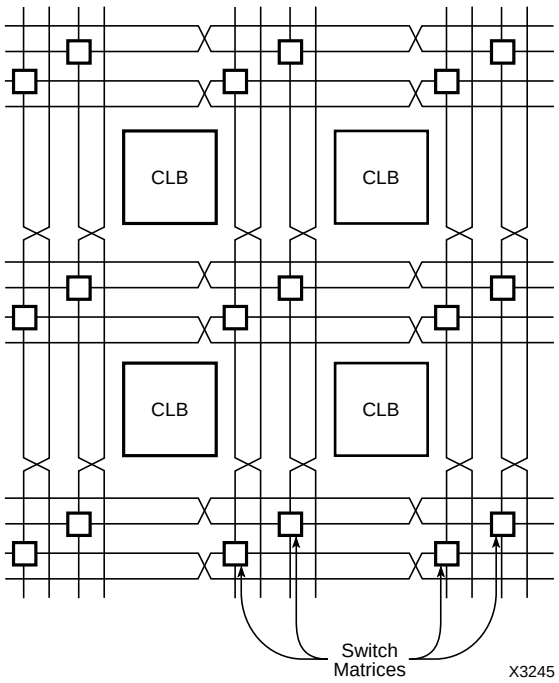


Figure 8. Double-Length Lines

Longlines form a grid of metal interconnect segments that run the entire length or width of the array (Figure 9). Additional vertical longlines can be driven by special global buffers, designed to distribute clocks and other high fanout control signals throughout the array with minimal skew. Longlines are intended for high fan-out, time-critical signal nets. Each Longline has a programmable splitter switch at its center, that can separate the line into two independent routing channels, each running half the width or height of the array. CLB inputs can be driven from a subset of the adjacent Longlines; CLB outputs are routed to the Longlines via 3-state buffers or the single-length interconnected lines.

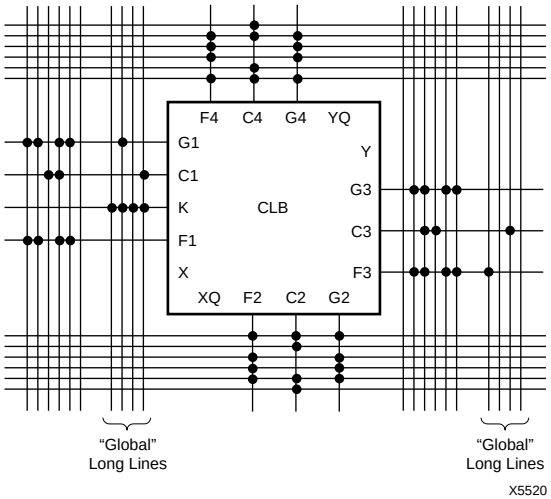


Figure 9. Longline Routing Resources with Typical CLB Connections

The inputs drive TTL-compatible buffers with 1.2-V input threshold and a slight hysteresis of about 300 mV. These buffers drive the internal logic as well as the D-input of the input flip-flop.

Under configuration control, the set-up time of this flip-flop can be increased so that normal clock routing does not result in a hold-time problem. Note that the input flip-flop set-up time is defined between the data measured at the device I/O pin and the clock input at the IOB. Any clock routing delay must, therefore, be subtracted from this set-up time to arrive at the real set-up time requirement on the device pins. A short specified set-up time might, therefore, result in a negative set-up time at the device pins, i.e. a hold-time requirement, which is usually undesirable. The default long set-up time can tolerate more clock delay without causing a hold-time requirement. For faster input register setup time, with non-zero hold, attach a "NODELAY" property to the flip-flop. The exact method to accomplish this depends on the design entry tool.

The input block has two connections to the internal logic, I1 and I2. Each of these is driven either by the incoming data, by the master or by the slave of the input flip-flop.

Wide Decoders

The periphery of the chip has four wide decoder circuits at each edge (two in the XC4000A). The inputs to each decoder are any of the I1 signals on that edge plus one local interconnect per CLB row or column. Each decoder generates High output (resistor pull-up) when the AND condition of the selected inputs, or their complements, is true. This is analogous to the AND term in typical PAL devices. Each decoder can be split at its center.

The decoder outputs can drive CLB inputs so they can be combined with other logic, or to form a PAL-like AND/OR structure. The decoder outputs can also be routed directly to the chip outputs. For fastest speed, the output should be on the same chip edge as the decoder.

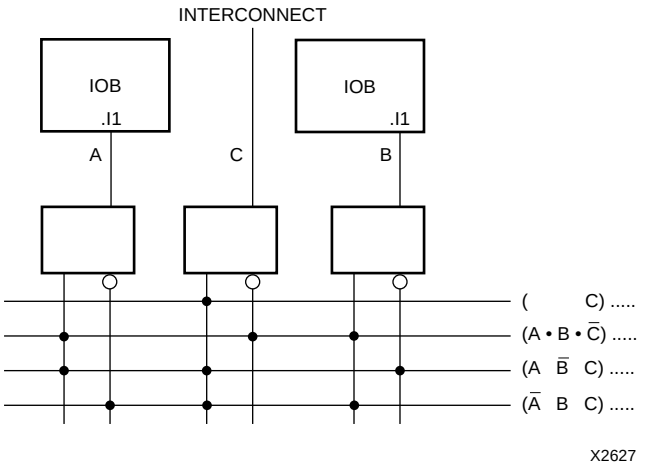


Figure 12. **Example of Edge Decoding.** Each row or column of CLBs provide up to three variables (or their complements)

Configurable Logic Blocks

Configurable Logic Blocks implement most of the logic in an LCA device. Two 4-input function generators (F and G) offer unrestricted versatility. A third function generator (H) can combine the outputs of F and G with a ninth input variable, thus implementing certain functions of up to nine variables, like parity check or expandable-identity comparison of two sets of four inputs.

The four control inputs C1 through C4 can each generate any one of four logic signals, used in the CLB.

- Enable Clock, Asynchronous Preset/Reset, DIN, and H1, when the memory function is disabled, or
- Enable Clock, Write Enable, D0, and D1, when the memory function is enabled.

Since the function-generator outputs are brought out independently of the flip-flop outputs, and DIN and H1 can be used as direct inputs to the two flip-flops, the two combinatorial and the two sequential functions in the CLB can be used independently. This versatility increases logic density and simplifies routing.

The asynchronous flip-flop input can be configured as either set or reset. This configuration option also determines the state in which the flip-flops become operational after configuration, as well as the effect of an externally or internally applied Set/Reset during normal operation.

Fast Carry Logic

The CLBs can generate the arithmetic-carry output for incoming operands, and can pass this extra output on to the next CLB function generator above or below. This connection is independent of normal routing resources and it is, presently, only supported by Hard Macros. A later software release will accommodate Soft Macros and will permit graphic editing of the fast logic circuitry. This fast carry logic is one of the most significant improvements in the XC4000 families, speeding up arithmetic and counting into the 60-MHz range.

Using Function Generators as RAMs

Using XC4000 devices, the designer can write into the latches that hold the configuration content of the function generators. Each function generator can thus be used as a small Read/Write memory, or RAM. The function generators in any CLB can be configured in three ways.

- Two 16 x 1 RAMs with two data inputs and two data outputs – identical or, if preferred, different addressing for each RAM
- One 32 x 1 RAM with one data input and one data output
- One 16 x 1 RAM plus one 5-input function generator

Boundary Scan

Boundary Scan is becoming an attractive feature that helps sophisticated systems manufacturers test their PC boards more safely and more efficiently. The XC4000 family implements IEEE 1149.1-compatible BYPASS, PRELOAD/SAMPLE and EXTEST Boundary-Scan instructions. When the Boundary-Scan configuration option is selected, three normal user I/O pins become dedicated inputs for these functions.

The "bed of nails" has been the traditional method of testing electronic assemblies. This approach has become less appropriate, due to closer pin spacing and more sophisticated assembly methods like surface-mount technology and multi-layer boards. The IEEE Boundary Scan standard 1149.1 was developed to facilitate board-level testing of electronic assemblies. Design and test engineers can imbed a standard test logic structure in their electronic design. This structure is easily implemented with the serial and/or parallel connections of a four-pin interface on any Boundary-Scan-compatible IC. By exercising these signals, the user can serially load commands and data into these devices to control the driving of their outputs and to examine their inputs. This is an improvement over bed-of-nails testing. It avoids the need to overdrive device outputs, and it reduces the user interface to four pins. An optional fifth pin, a reset for the control logic, is described in the standard but is not implemented in the Xilinx part.

The dedicated on-chip logic implementing the IEEE 1149.1 functions includes a 16-state machine, an instruction register and a number of data registers. A register operation begins with a *capture* where a set of data is parallel loaded into the designated register for shifting out. The next state is *shift*, where captured data are shifted out while the desired data are shifted in. A number of states are provided for Wait operations. The last state of a register sequence is the *update* where the shifted content of the register is loaded into the appropriate instruction- or data-holding register, either for instruction-register decode or for data-register pin control.

The primary data register is the Boundary-Scan register. For each IOB pin in the LCA device, it includes three bits of shift register and three *update* latches for: in, out and 3-state control. Non-IOB pins have appropriate partial bit population for in or out only. Each Extest Capture captures all available input pins.

The other standard data register is the single flip-flop *bypass* register. It resynchronizes data being passed through a device that need not be involved in the current scan operation. The LCA device provides two user nets (BSCAN.SEL1 and BSCAN.SEL2) which are the decodes of two user instructions. For these instructions, two corresponding nets (BSCAN.TDO1 and BSCAN.TDO2) allow user scan data to be shifted out on TDO. The data register clock (BSCAN.DRCK) is available for control of test logic which the user may wish to implement with CLBs. The NAND of TCK and Run-test-idle is also provided (BSCAN.IDLE).

The XC4000 Boundary Scan instruction set also includes instructions to configure the device and read back the configuration data.

Table 4. Boundary Scan Instruction

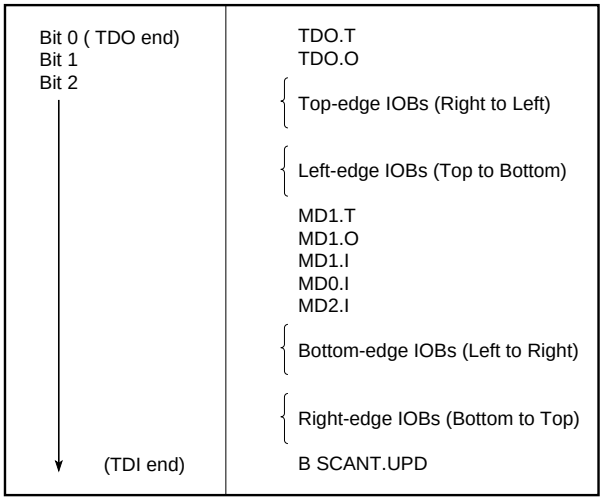
Instruction I_2	I_1	I_0	Test Selected	TDO Source	I/O Data Source
0	0	0	Extest	DR	DR
0	0	1	Sample/Preload	DR	Pin/Logic
0	1	0	User 1	TDO1	Pin/Logic
0	1	1	User 2	TDO2	Pin/Logic
1	0	0	Readback	Readback Data	Pin/Logic
1	0	1	Configure	DOUT	Disabled
1	1	0	Reserved	—	—
1	1	1	Bypass	Bypass Reg	Pin/Logic

X2679

Bit Sequence

The bit sequence within each IOB is: in, out, 3-state. From a cavity-up (XDE) view of the chip, starting in the upper right chip corner, the Boundary-Scan data-register bits have the following order.

Table 5. Boundary Scan Order



X6075

The data register also includes the following non-pin bits: TDO.T, and TDO.I, which are always bits 0 and 1 of the data register, respectively, and BSCANT.UPD which is always the last bit of the data register. These three Boundary-Scan bits are special-purpose Xilinx test signals. PROGRAM, CCLK and DONE are not included in the Boundary-Scan register. For more information regarding Boundary Scan, refer to XAPP 017.001, *Boundary Scan in XC4000 Devices*.

Interconnects

The XC4000 families use a hierarchy of interconnect resources.

- General purpose single-length and double-length lines offer fast routing between adjacent blocks, and highest flexibility for complex routes, but they incur a delay every time they pass through a switch matrix.
- Longlines run the width or height of the chip with negligible delay variations. They are used for signal distribution over long distances. Some Horizontal Longlines can be driven by 3-state or open-drain drivers, and can thus implement bidirectional buses or wired-AND decoding.
- Global Nets are optimized for the distribution of clock and time-critical or high-fan-out control signal. Four pad-driven Primary Global Nets offer shortest delay and negligible skew. Four pad-driven Secondary Global Nets have slightly longer delay and more skew due to heavier loading.

Each CLB column has four dedicated Vertical Longlines, each of these lines has access to a particular Primary Global Net, or to any one of the Secondary Global Nets. The Global Nets avoid clock skew and potential hold-time problems. The user must specify these Global Nets for all timing-sensitive global signal distribution.

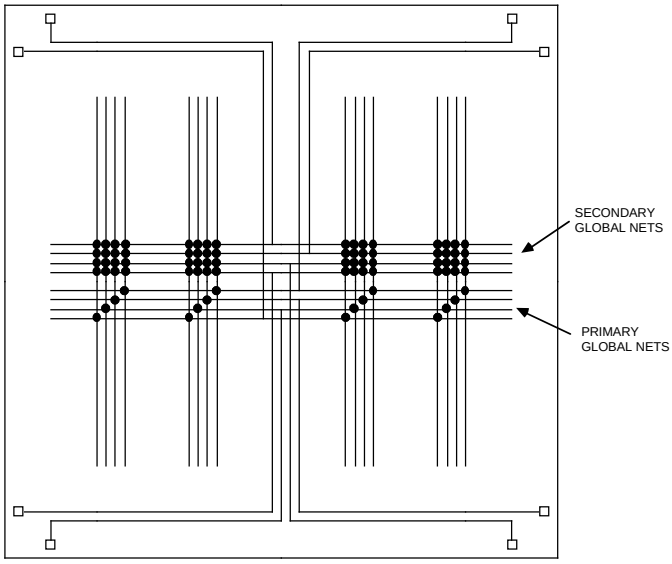
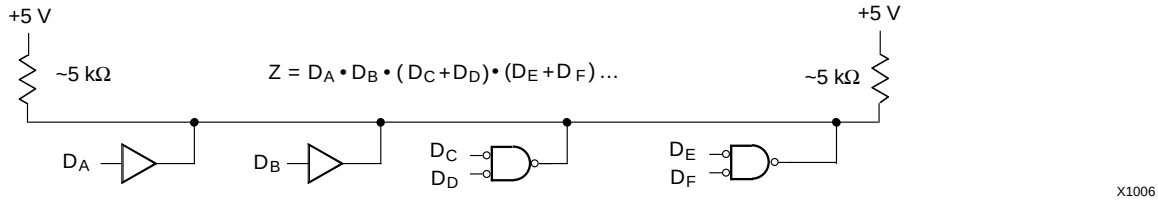
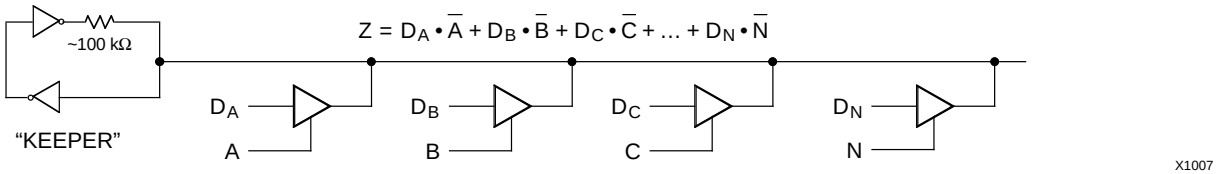


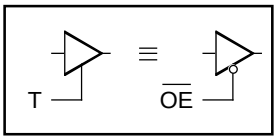
Figure 17. XC4000 Global Net Distribution. Four Lines per Column; Eight Inputs in the Four Chip Corners.



Open Drain Buffers Implement a Wired-AND Function. When all the buffer inputs are High the pull-up resistor(s) provide the High output.



3-State Buffers Implement a Multiplexer. The selection is accomplished by the buffer 3-state signal.



Active High T is Identical to Active Low Output Enable.

Figure 18. TBUFs Driving Horizontal Longlines.

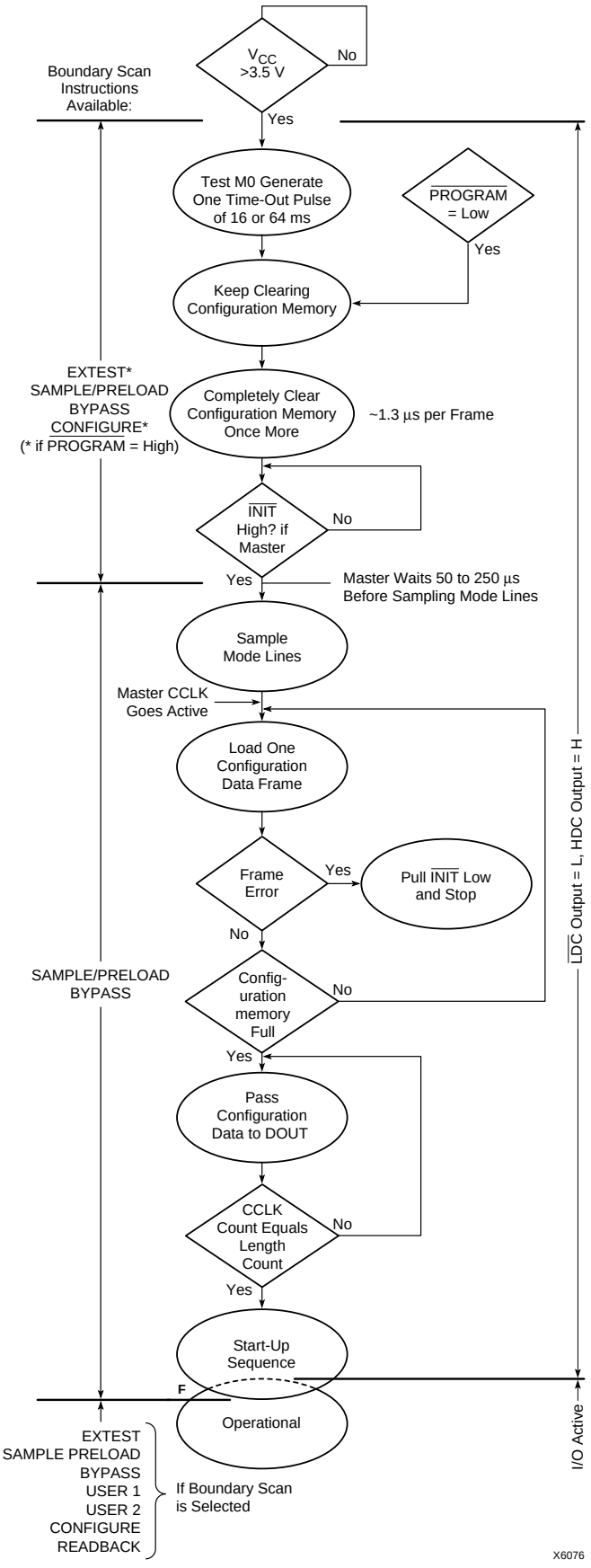


Figure 20. Start-up Sequence

device when it recognizes the 0010 preamble. Following the length-count data, any LCA device outputs a High on DOUT until it has received its required number of data frames.

After an LCA device has received its configuration data, it passes on any additional frame start bits and configuration data on DOUT. When the total number of configuration clocks applied after memory initialization equals the value of the 24-bit length count, the LCA device(s) begin the start-up sequence and become operational together.

Configuration Sequence

Configuration Memory Clear

When power is first applied or reapplied to an LCA device, an internal circuit forces initialization of the configuration logic. When V_{CC} reaches an operational level, and the circuit passes the write and read test of a sample pair of configuration bits, a nominal 16-ms time delay is started (four times longer when M0 is Low, i.e., in Master mode). During this time delay, or as long as the PROGRAM input is asserted, the configuration logic is held in a Configuration Memory Clear state. The configuration-memory frames are consecutively initialized, using the internal oscillator. At the end of each complete pass through the frame addressing, the power-on time-out delay circuitry and the level of the PROGRAM pin are tested. If neither is asserted, the logic initiates one additional clearing of the configuration frames and then tests the INIT input.

Initialization

During initialization and configuration, user pins HDC, LDC and INIT provide status outputs for system interface. The outputs, LDC, INIT and DONE are held Low and HDC is held High starting at the initial application of power. The open drain INIT pin is released after the final initialization pass through the frame addresses. There is a deliberate delay of 50 to 250 µs before a Master-mode device recognizes an inactive INIT. Two internal clocks after the INIT pin is recognized as High, the LCA device samples the three mode lines to determine the configuration mode. The appropriate interface lines become active and the configuration preamble and data can be loaded.

Configuration

The 0010 preamble code indicates that the following 24 bits represent the length count, i.e., the total number of configuration clocks needed to load the total configuration data. After the preamble and the length count have been passed through to all devices in the daisy chain, DOUT is held High to prevent frame start bits from reaching any daisy-chained devices. A specific configuration bit, early in the first frame of a master device, controls the configuration-clock rate and can increase it by a factor of eight. Each frame has a Low start bit followed by the frame-configura-

tion data bits and a 4-bit frame error field. If a frame data error is detected, the LCA device halts loading, and signals the error by pulling the open-drain INIT pin Low.

After all configuration frames have been loaded into an LCA device, DOUT again follows the input data so that the remaining data is passed on to the next device.

Start-Up

Start-up is the transition from the configuration process to the intended user operation. This means a change from one clock source to another, and a change from interfacing parallel or serial configuration data where most outputs are 3-stated, to normal operation with I/O pins active in the user-system. Start-up must make sure that the user-logic "wakes up" gracefully, that the outputs become active without causing contention with the configuration signals, and that the internal flip-flops are released from the global Reset or Set at the right time.

Figure 21 describes Start-up timing for the three Xilinx families in detail.

The **XC2000** family goes through a fixed sequence:

DONE goes High and the internal global Reset is de-activated one CCLK period after the I/O become active.

The **XC3000A** family offers some flexibility: DONE can be programmed to go High one CCLK period before or after the I/O become active. Independent of DONE, the internal global Reset is de-activated one CCLK period before or after the I/O become active.

The **XC4000** family offers additional flexibility: The three events, DONE going High, the internal Reset/Set being de-activated, and the user I/O going active, can all occur in any arbitrary sequence, each of them one CCLK period before or after, or simultaneous with, any of the other.

The default option, and the most practical one, is for DONE to go High first, disconnecting the configuration data source and avoiding any contention when the I/Os become active one clock later. Reset/Set is then released another clock period later to make sure that user-operation starts from stable internal conditions. This is the most common sequence, shown with heavy lines in Figure 21, but the designer can modify it to meet particular requirements.

The XC4000 family offers another start-up clocking option: The three events described above don't have to be triggered by CCLK, they can, as a configuration option, be triggered by a user clock. This means that the device can wake up in synchronism with the user system.

The XC4000 family introduces an additional option: When this option is enabled, the user can externally hold the open-drain DONE output Low, and thus stall all further progress in the Start-up sequence, until DONE is released and has gone High. This option can be used to force synchronization of several LCA devices to a common user clock, or to guarantee that all devices are successfully configured before any I/Os go active.

Start-up Sequence

The Start-up sequence begins when the configuration memory is full, and the total number of configuration clocks received since INIT went High equals the loaded value of the length count. The next rising clock edge sets a flip-flop Q0 (see Figure 22), the leading bit of a 5-bit shift register.

The outputs of this register can be programmed to control three events.

- The release of the open-drain DONE output,
- The change of configuration-related pins to the user function, activating all IOBs.
- The termination of the global Set/Reset initialization of all CLB and IOB storage elements.

The DONE pin can also be wire-ANDed with DONE pins of other LCA devices or with other external signals, and can then be used as input to bit Q3 of the start-up register. This is called "Start-up Timing Synchronous to Done In" and labeled: CCLK_SYNC or UCLK_SYNC. When DONE is not used as an input, the operation is called Start-up Timing Not Synchronous to DONE In, and is labeled CCLK_NOSYNC or UCLK_NOSYNC. These labels are not intuitively obvious.

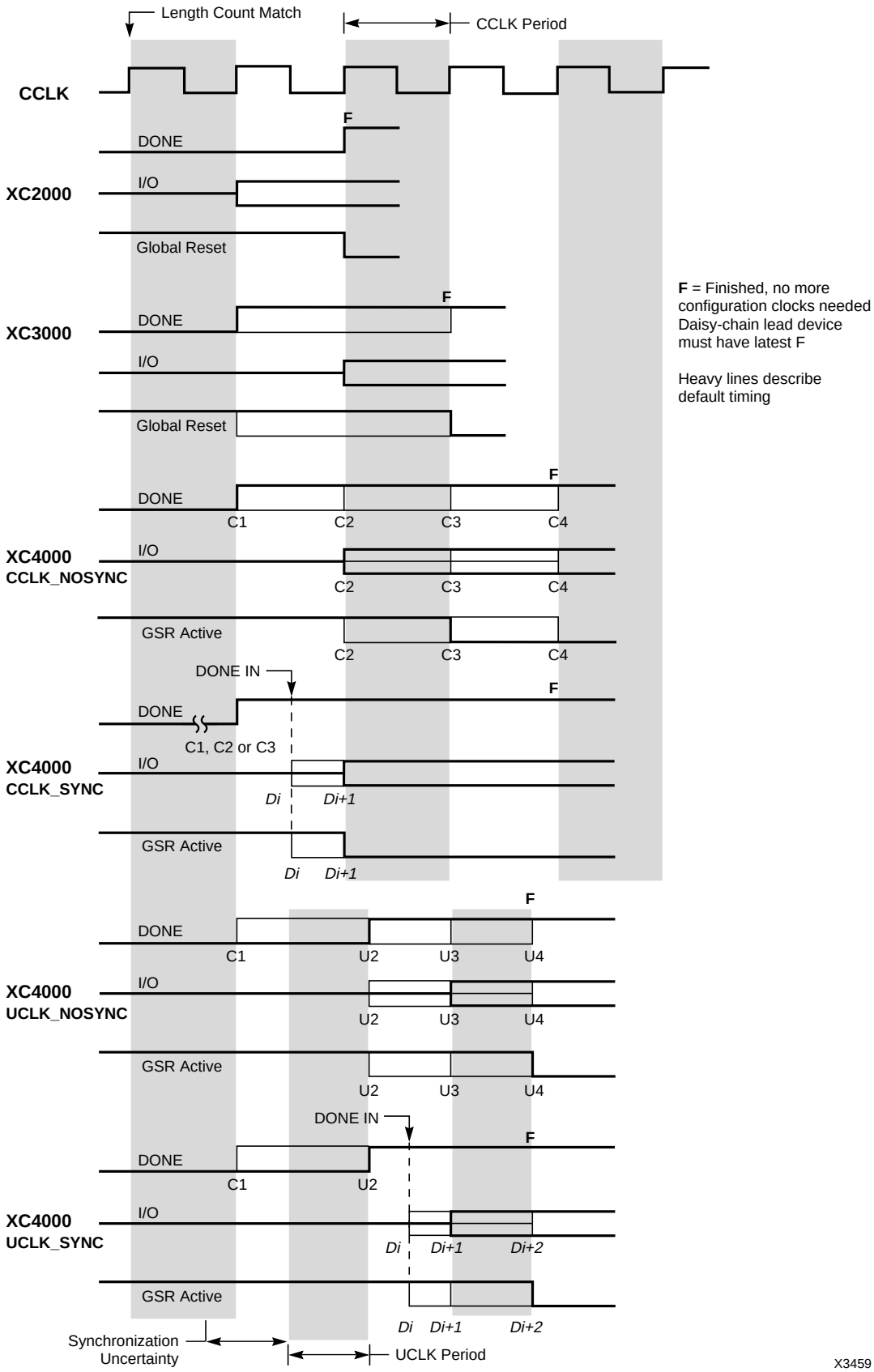
As a configuration option, the start-up control register beyond Q0 can be clocked either by subsequent CCLK pulses or from an on-chip user net called STARTUP.CLK.

Start-up from CCLK

If CCLK is used to drive the start-up, Q0 through Q3 provide the timing. Heavy lines in Figure 21 show the default timing which is compatible with XC2000 and XC3000 devices using early DONE and late Reset.The thin lines indicate all other possible timing options.

Start-up from a User Clock (STARTUP.CLK)

When, instead of CCLK, a user-supplied start-up clock is selected, Q1 is used to bridge the unknown phase relationship between CCLK and the user clock. This arbitration causes an unavoidable one-cycle uncertainty in the timing of the rest of the start-up sequence.



Note: Thick lines are default option.

Figure 21. Start-up Timing

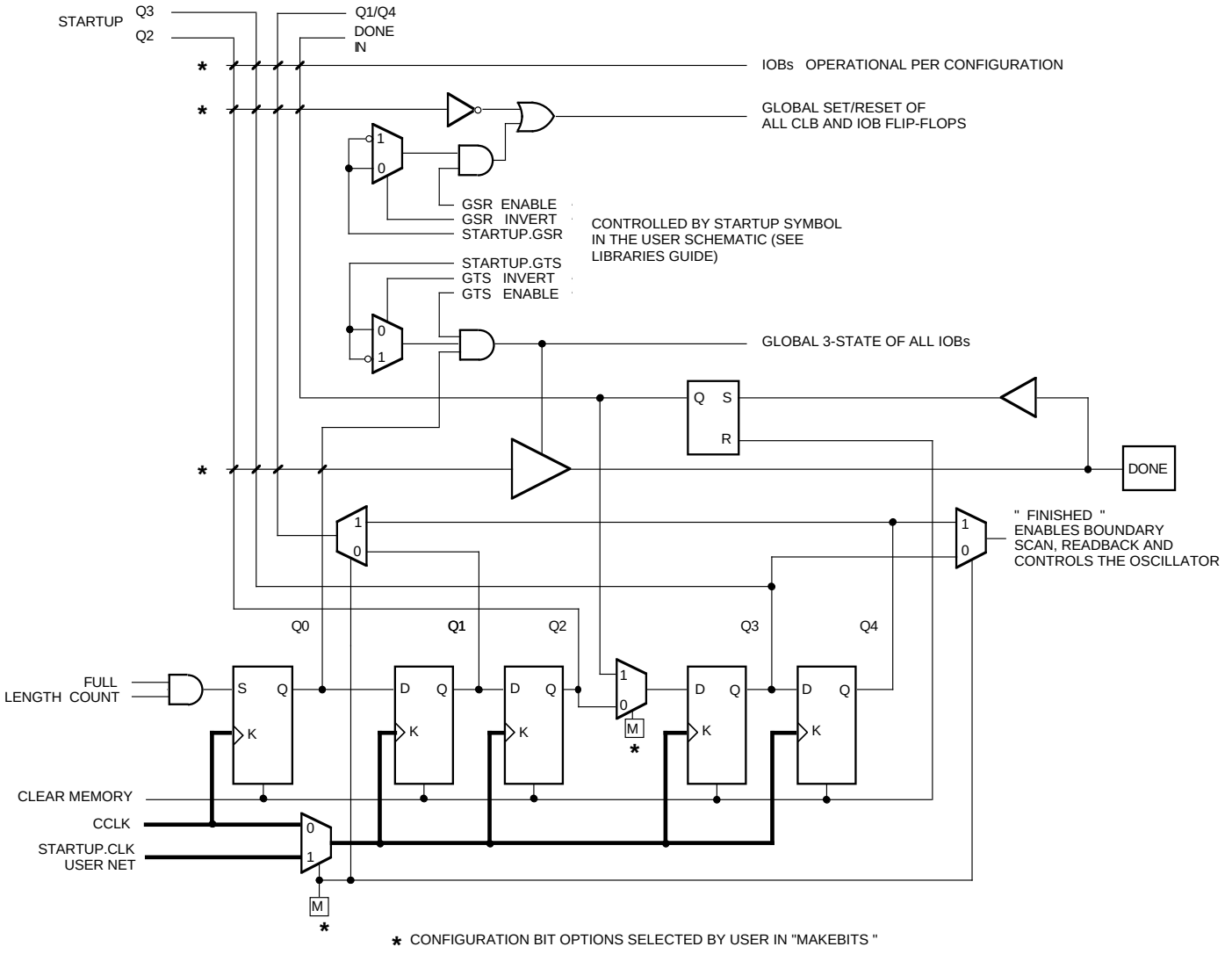


Figure 22. Start-up Logic

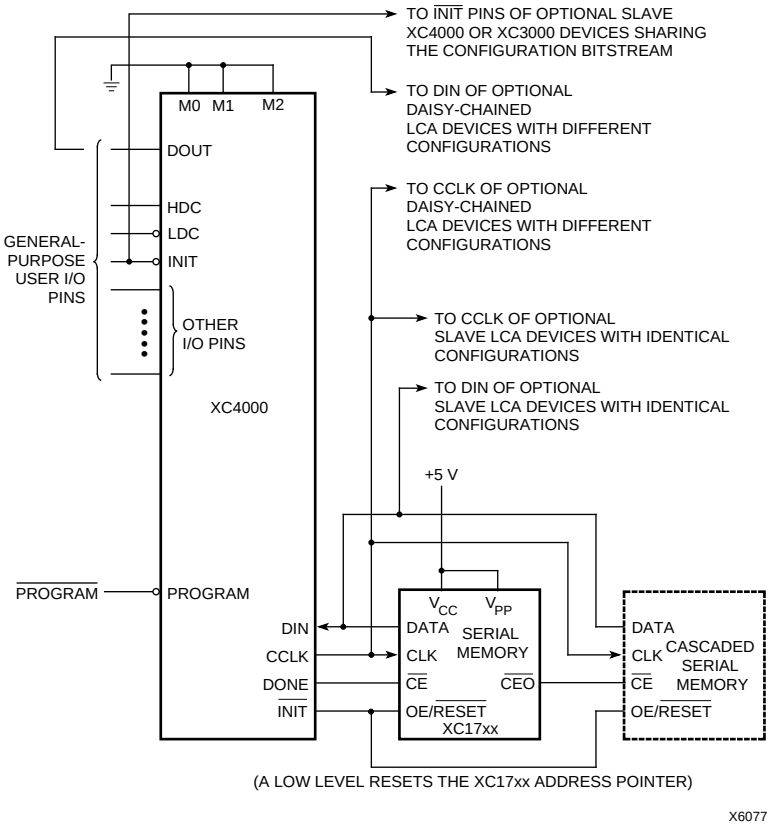
All Xilinx FPGAs of the XC2000, XC3000, XC4000 familiies use a compatible bitstream format and can, therefore, be connected in a daisy-chain in an arbitrary sequence. There is however one limitation. The lead device must belong to the highest family in the chain. If the chain contains XC4000 devices, the master cannot be an XC2000 or XC3000 device; if the daisy-chain contains XC3000 devices, the master cannot be an XC2000 device. The reason for this rule is shown in Figure 21 on the previous page. Since all devices in the chain store the same length count value and generate or receive one common sequence of CCLK pulses, they all recognize length-count match on the same CCLK edge, as indicated on the left edge of Figure 21. The master device will then drive additional CCLK pulses until it reaches its finish point F. The different families generate or require different numbers of additional CCLK pulses until they reach F.

Not reaching F means that the device does not really finish its configuration, although DONE may have gone High, the outputs became active, and the internal RESET was released. The user has some control over the relative timing of these events and can, therefore, make sure that they occur early enough.

But, for XC4000, not reaching F means that READBACK cannot be initiated and most Boundary Scan instructions cannot be used.This limitation has been critized by designers who want to use an inexpensive lead device in peripheral mode and have the more precious I/O pins of the XC4000 devices all available for user I/O. Here is a solution for that case.

One CLB and one IOB in the lead XC3000 device are used to generate the additional CCLK pulse required by the XC4000 devices. When the lead device removes the internal RESET signal, the 2-bit shift register responds to its clock input and generates an active Low output signal for the duration of the subsequent clock period. An external connection between this output and CCLK thus creates

Master Serial Mode



In Master Serial mode, the CCLK output of the lead LCA device drives a Xilinx Serial PROM that feeds the LCA DIN input. Each rising edge of the CCLK output increments the Serial PROM internal address counter. This puts the next data bit on the SPROM data output, connected to the LCA DIN pin. The lead LCA device accepts this data on the subsequent rising CCLK edge.

The lead LCA device then presents the preamble data (and all data that overflows the lead device) on its DOUT pin. There is an internal pipeline delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next LCA device in the daisy-chain accepts data on the subsequent rising CCLK edge. The user can specify Fast ConfigRate, which starting somewhere in the first frame, increases the CCLK frequency eight times, from a value between 0.5 and 1.25 MHz, to a value between 4 and 10 MHz. Note that most Serial PROMs are not compatible with this high frequency.

The SPROM CE input can be driven from either LDC or DONE. Using LDC avoids potential contention on the DIN pin, if this pin is configured as user-I/O, but LDC is then restricted to be a permanently High user output. Using DONE can also avoid contention on DIN, provided the early DONE option is invoked.

How to Delay Configuration After Power-Up

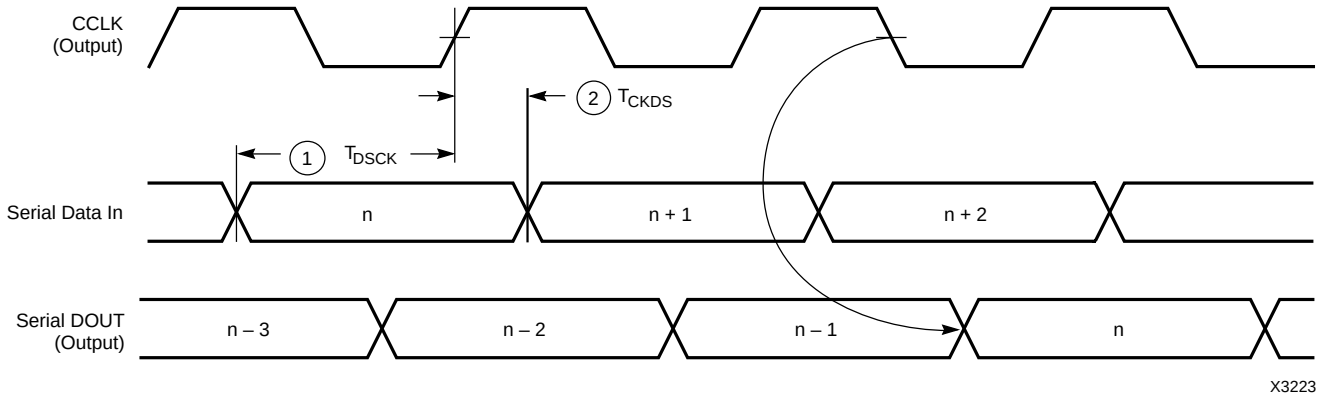
There are two methods to delay configuration after power-up: Put a logic Low on the PROGRAM input, or pull the bidirectional INIT pin Low, using an open-collector (open-drain) driver. (See also Figure 20 on page 2-27.)

A Low on the PROGRAM input is the more radical approach, and is recommended when the power-supply rise time is excessive or poorly defined. As long as PROGRAM is Low, the XC4000 device keeps clearing its configuration memory. When PROGRAM goes High, the configuration memory is cleared one more time, followed by the beginning of configuration, provided the INIT input is not externally held Low. Note that a Low on the PROGRAM input automatically forces a Low on the INIT output.

Using an open-collector or open-drain driver to hold INIT Low before the beginning of configuration, causes the LCA device to wait after having completed the configuration memory clear operation. When INIT is no longer held Low

externally, the device determines its configuration mode by capturing its status inputs, and is ready to start the configuration process. A master device waits an additional up to 250 µs to make sure that all slaves in the potential daisy-chain have seen INIT being High.

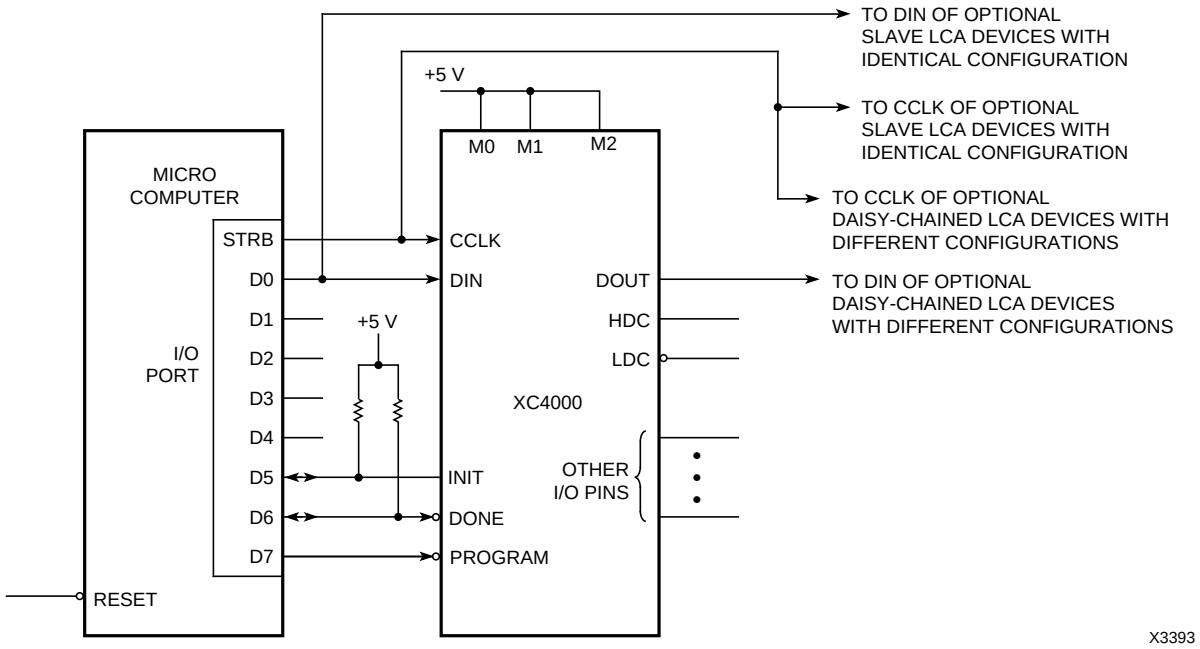
Master Serial Mode Programming Switching Characteristics



	Description	Symbol		Min	Max	Units
CCLK	Data In setup	1	T_{DSCK}	20		ns
	Data In hold	2	T_{CKDS}	0		ns

Notes: 1. At power-up, V_{CC} must rise from 2.0 V to Vcc min in less than 25 ms, otherwise delay configuration by pulling PROGRAM Low until V_{CC} is valid.
2. Configuration can be controlled by holding INIT Low with or until after the INIT of all daisy-chain slave mode devices is High.
3. Master-serial-mode timing is based on testing in slave mode.

Slave Serial Mode



In Slave Serial mode, an external signal drives the CCLK input(s) of the LCA device(s). The serial configuration bitstream must be available at the DIN input of the lead LCA device a short set-up time before each rising CCLK edge. The lead LCA device then presents the preamble data (and all data that overflows the lead device) on its DOUT pin.

There is an internal delay of 0.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next LCA device in the daisy-chain accepts data on the subsequent rising CCLK edge.

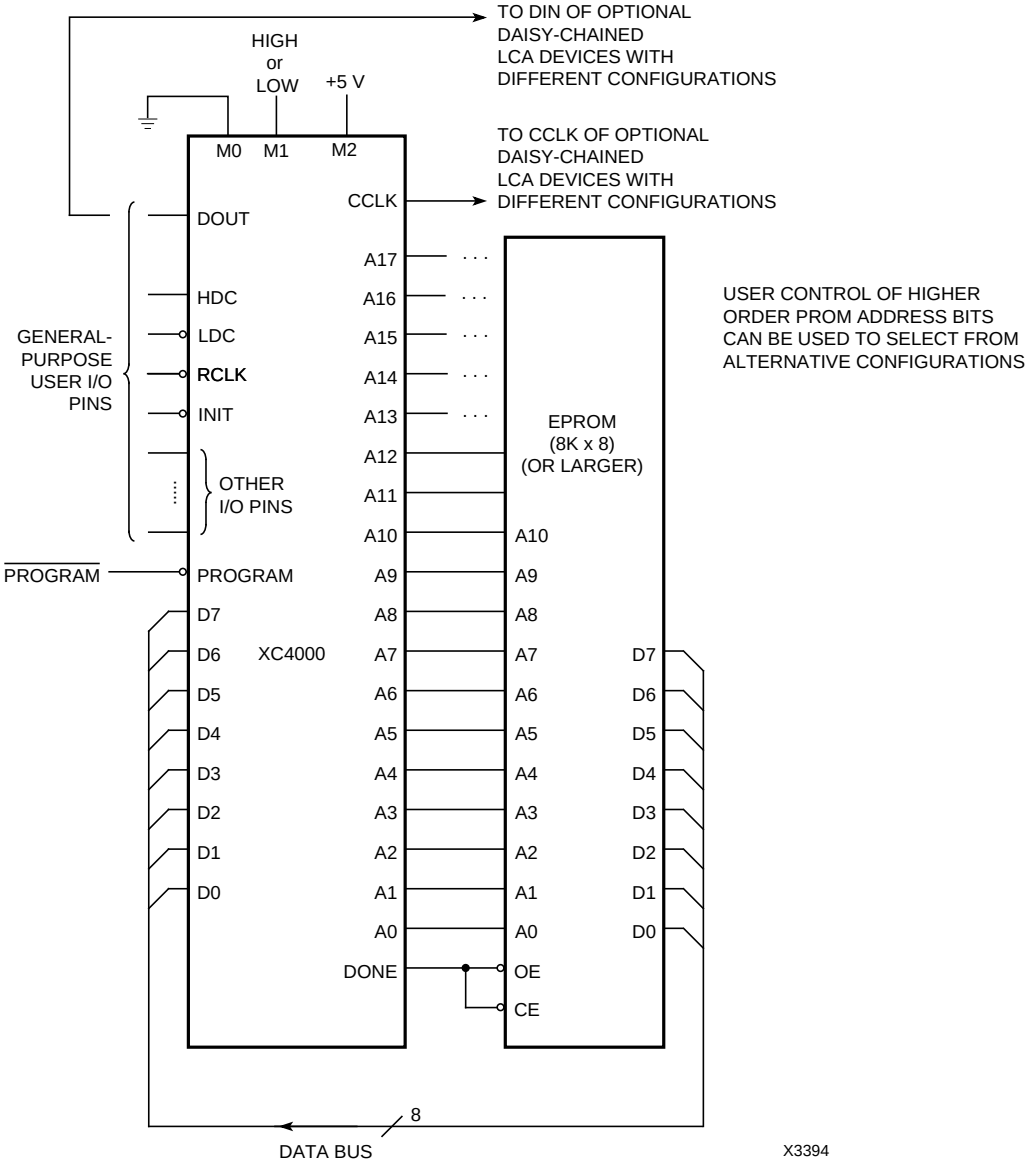
How to Delay Configuration After Power-Up

There are two methods to delay configuration after power-up: Put a logic Low on the PROGRAM input, or pull the bidirectional INIT pin Low, using an open-collector (open-drain) driver. (See also Figure 20 on page 2-27.)

A Low on the PROGRAM input is the more radical approach, and is recommended when the power-supply rise time is excessive or poorly defined. As long as PROGRAM is Low, the XC4000 device keeps clearing its configuration memory. When PROGRAM goes High, the configuration memory is cleared one more time, followed by the beginning of configuration, provided the INIT input is not externally held Low. Note that a Low on the PROGRAM input automatically forces a Low on the INIT output.

Using an open-collector or open-drain driver to hold INIT Low before the beginning of configuration, causes the LCA device to wait after having completed the configuration memory clear operation. When INIT is no longer held Low externally, the device determines its configuration mode by capturing its status inputs, and is ready to start the configuration process. A master device waits an additional max 250 µs to make sure that all slaves in the potential daisy-chain have seen INIT being High.

Master Parallel Mode



In Master Parallel mode, the lead LCA device directly addresses an industry-standard byte-wide EPROM, and accepts eight data bits right before incrementing (or decrementing) the address outputs.

The eight data bits are serialized in the lead LCA device, which then presents the preamble data (and all data that overflows the lead device) on the DOUT pin. There is an internal delay of 1.5 CCLK periods, after the rising CCLK edge that accepts a byte of data (and also changes the EPROM address) until the falling CCLK edge that makes the LSB (D0) of this byte appear at DOUT. This means that DOUT changes on the falling CCLK edge, and the next LCA device in the daisy-chain accepts data on the subsequent rising CCLK edge.

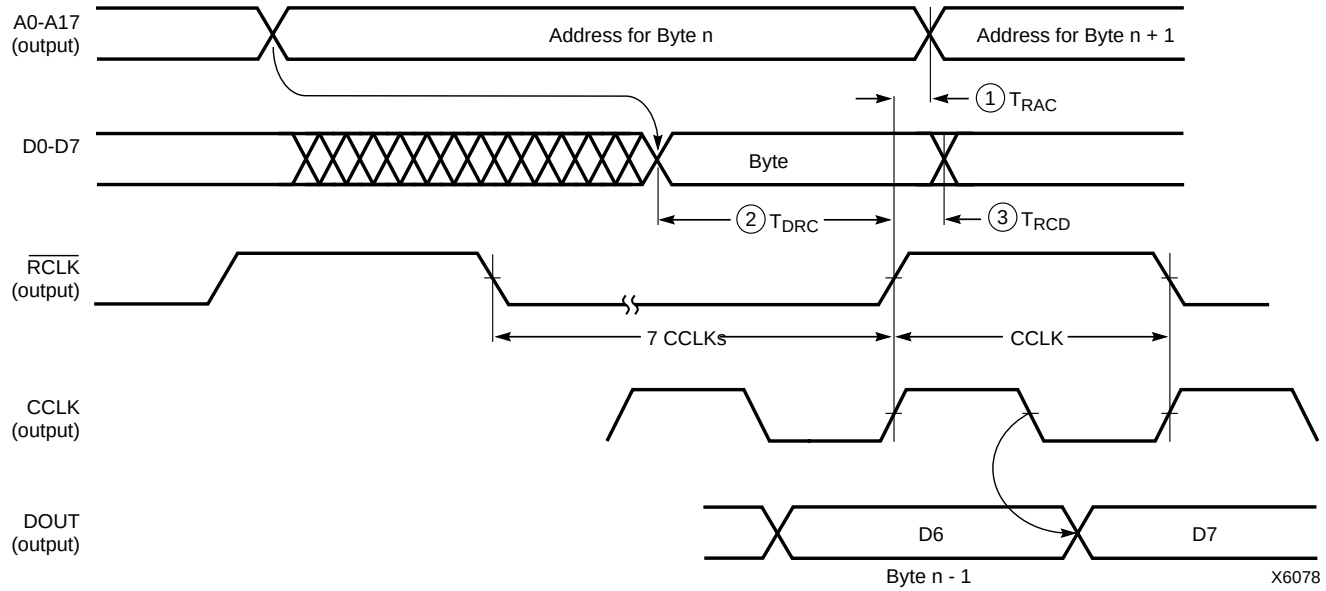
How to Delay Configuration After Power-Up

There are two methods to delay configuration after power-up: Put a logic Low on the PROGRAM input, or pull the bidirectional INIT pin Low, using an open-collector (open-drain) driver. (See also Figure 20 on page 2-27).

A Low on the PROGRAM input is the more radical approach, and is recommended when the power-supply rise time is excessive or poorly defined. As long as PROGRAM is Low, the XC4000 device keeps clearing its configuration memory. When PROGRAM goes High, the configuration memory is cleared one more time, followed by the beginning of configuration, provided the INIT input is not externally held Low. Note that a Low on the PROGRAM input automatically forces a Low on the INIT output.

Using an open-collector or open-drain driver to hold INIT Low before the beginning of configuration, causes the LCA device to wait after having completed the configuration memory clear operation. When INIT is no longer held Low externally, the device determines its configuration mode by capturing its status inputs, and is ready to start the configuration process. A master device waits an additional max 250 µs to make sure that all slaves in the potential daisy-chain have seen INIT being High.

Master Parallel Mode Programming Switching Characteristics

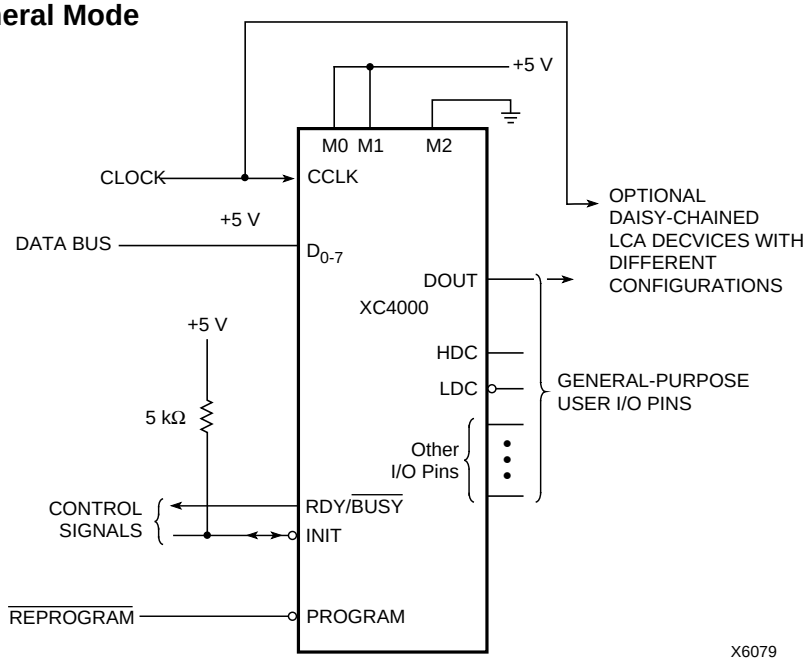


	Description	Symbol		Min	Max	Units
RCLK	Delay to Address valid	1	T_{RAC}	0	200	ns
	Data setup time	2	T_{DRC}	60		ns
	Data hold time	3	T_{RCD}	0		ns

Notes: 1. At power-up, V_{CC} must rise from 2.0 V to Vcc min in less than 25 ms, otherwise delay configuration using PROGRAM until V_{CC} is valid.
2. Configuration can be delayed by holding INIT Low with or until after the INIT of all daisy-chain slave mode devices is High.
3. The first Data byte is loaded and CCLK starts at the end of the first RCLK active cycle (rising edge).

This timing diagram shows that the EPROM requirements are extremely relaxed: EPROM access time can be longer than 500 ns. EPROM data output has no hold-time requirements.

Synchronous Peripheral Mode



Synchronous Peripheral mode can also be considered Slave Parallel mode. An external signal drives the CCLK input(s) of the LCA device(s). The first byte of parallel configuration data must be available at the D inputs of the lead LCA device a short set-up time before the rising CCLK edge. Subsequent data bytes are clocked in on every eighth consecutive rising CCLK edge. The same CCLK edge that accepts data, also causes the RDY/BUSY output to go High for one CCLK period. The pin name is a misnomer. In Synchronous Peripheral mode it is really an ACKNOWLEDGE signal. Synchronous operation does not require this response, but it is a meaningful signal for test purposes.

The lead LCA device serializes the data and presents the preamble data (and all data that overflows the lead device) on its DOUT pin. There is an internal delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next LCA device in the daisy-chain accepts data on the subsequent rising CCLK edge. In order to complete the serial shift operation, 10 additional CCLK rising edges are required after the last data byte has been loaded, plus one more CCLK cycle for each daisy-chained device.

How to Delay Configuration After Power-Up

There are two methods to delay configuration after power-up: Put a logic Low on the PROGRAM input, or pull the bidirectional INIT pin Low, using an open-collector (open-drain) driver. (See also Figure 20 on page 2-27).

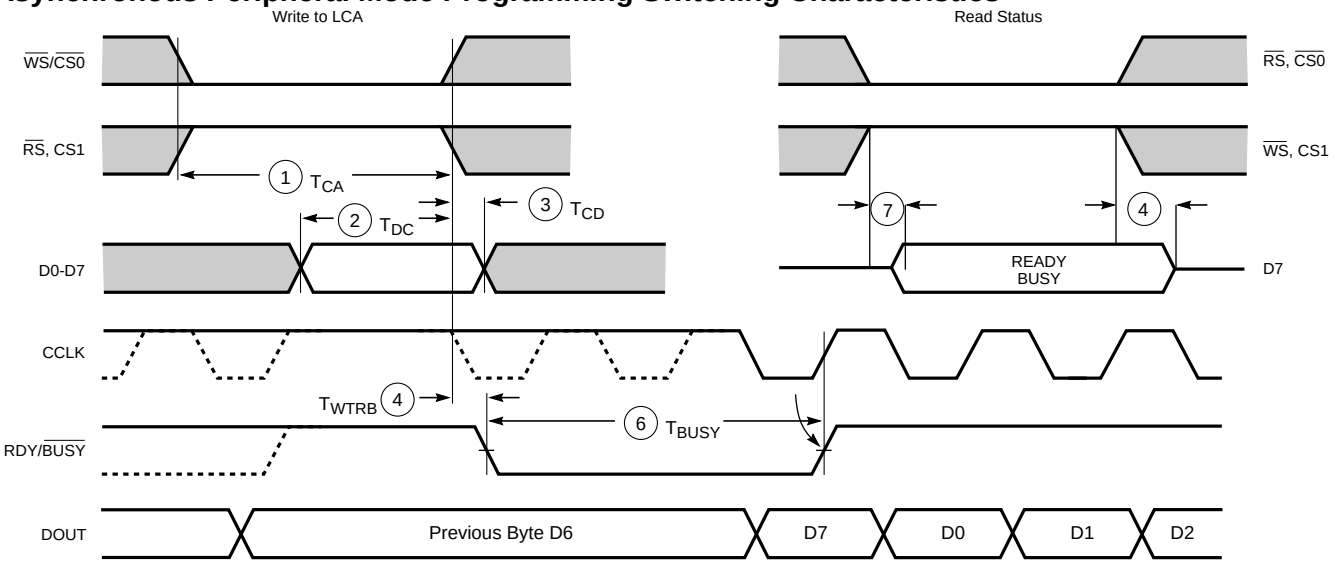
A Low on the PROGRAM input is the more radical approach, and is recommended when the power-supply rise time is excessive or poorly defined. As long as PROGRAM is Low, the XC4000 device keeps clearing its configuration memory. When PROGRAM goes High, the configuration memory is cleared one more time, followed by the beginning of configuration, provided the INIT input is not externally held Low. Note that a Low on the PROGRAM input automatically forces a Low on the INIT output.

Using an open-collector or open-drain driver to hold INIT Low before the beginning of configuration, causes the LCA device to wait after having completed the configuration memory clear operation. When INIT is no longer held Low externally, the device determines its configuration mode by capturing its status inputs, and is ready to start the configuration process. A master device waits an additional max 250 µs to make sure that all slaves in the potential daisy-chain have seen INIT being High.

A Low on the PROGRAM input is the more radical approach, and is recommended when the power-supply rise time is excessive or poorly defined. As long as PROGRAM is Low, the XC4000 device keeps clearing its configuration memory. When PROGRAM goes High, the configuration memory is cleared one more time, followed by the beginning of configuration, provided the INIT input is not externally held Low. Note that a Low on the PROGRAM input automatically forces a Low on the INIT output.

Using an open-collector or open-drain driver to hold INIT Low before the beginning of configuration, causes the LCA device to wait after having completed the configuration memory clear operation. When INIT is no longer held Low externally, the device determines its configuration mode by capturing its status inputs, and is ready to start the configuration process. A master device waits an additional max 250 µs to make sure that all slaves in the potential daisy-chain have seen INIT being High.

Asynchronous Peripheral Mode Programming Switching Characteristics



X6097

	Description	Symbol		Min	Max	Units
Write	Effective Write time required (CS0, WS = Low, RS, CS1 = High)	1	T_{CA}	100		ns
	DIN Setup time required	2	T_{DC}	60		ns
	DIN Hold time required	3	T_{CD}	0		ns
	RDY/BUSY delay after end of Write or Read	4	T_{WTRB}		60	ns
	RDY/BUSY active after begining of Read	7			60	ns
RDY	Earliest next WS after end of BUSY	5	T_{RBWT}	0		ns
	BUSY Low output (Note 4)	6	T_{BUSY}	2	9	CCLK Periods

Notes:
1. Configuration must be delayed until the INIT of all LCA devices is High.
2. Time from end of WS to CCLK cycle for the new byte of data depends on completion of previous byte processing and the phase of the internal timing generator for CCLK.
3. CCLK and DOUT timing is tested in slave mode.
4. T_{BUSY} indicates that the double-buffered parallel-to-serial converter is not yet ready to receive new data. The shortest T_{BUSY} occurs when a byte is loaded into an empty parallel-to-serial converter. The longest T_{BUSY} occurs when a new word is loaded into the input register before the second-level buffer has started shifting out data.

This timing diagram shows very relaxed requirements:
Data need not be held beyond the rising edge of WS. BUSY will go active within 60 ns after the end of WS.
WS may be asserted immediately after the end of BUSY.

HDC

High During Configuration is driven High until configuration is completed. It is available as a control output indicating that configuration is not yet completed. After configuration, this is a user-programmable I/O pin.

LDC

Low During Configuration is driven Low until configuration. It is available as a control output indicating that configuration is not yet completed. After configuration, this is a user-programmable I/O pin.

INIT

Before and during configuration, this is a bidirectional signal. An external pull-up resistor is recommended.

As an active-Low open-drain output, INIT is held Low during the power stabilization and internal clearing of the configuration memory. As an active-Low input, it can be used to hold the LCA device in the internal WAIT state before the start of configuration. Master mode devices stay in a WAIT state an additional 30 to 300 µs after INIT has gone High.

During configuration, a Low on this output indicates that a configuration data error has occurred. After configuration, this is a user-programmable I/O pin.

PGCK1 - PGCK4

Four Primary Global Inputs each drive a dedicated internal global net with short delay and minimal skew. If not used for this purpose, any of these pins is a user-programmable I/O.

SGCK1 - SGCK4

Four Secondary Global Inputs can each drive a dedicated internal global net, that alternatively can also be driven from internal logic. If not used for this purpose, any of these pins is a user-programmable I/O pin.

CS0, CS1, WS, RS

These four inputs are used in Peripheral mode. The chip is selected when CS0 is Low and CS1 is High. While the chip is selected, a Low on Write Strobe (WS) loads the data present on the D0 - D7 inputs into the internal data buffer; a Low on Read Strobe (RS) changes D7 into a status output: High if Ready, Low if Busy, and D0…D6 are active Low. WS and RS should be mutually exclusive, but if both are Low simultaneously, the Write Strobe overrides. After configuration, these are user-programmable I/O pins.

A0 - A17

During Master Parallel mode, these 18 output pins address the configuration EPROM. After configuration, these are user-programmable I/O pins.

D0 - D7

During Master Parallel and Peripheral configuration modes, these eight input pins receive configuration data. After configuration, they are user-programmable I/O pins.

DIN

During Slave Serial or Master Serial configuration modes, this is the serial configuration data input receiving data on the rising edge of CCLK.

During parallel configuration modes, this is the D0 input. After configuration, DIN is a user-programmable I/O pin.

DOUT

During configuration in any mode, this is the serial configuration data output that can drive the DIN of daisy-chained slave LCA devices. DOUT data changes on the falling edge of CCLK, one-and-a-half CCLK periods after it was received at the DIN input. After configuration, DOUT is a user-programmable I/O pin.

Unrestricted User-Programmable I/O Pins

I/O

A pin that can be configured to be input and/or output after configuration is completed. Before configuration is completed, these pins have an internal high-value pull-up resistor that defines the logic level as High.

Before and during configuration, all outputs that are not used for the configuration process are 3-stated with a 50 kΩ to 100 kΩ pull-up resistor.